

S155SGC-2S-2A

3.2x2.7mm, Deep Red & Yellow Green LED

Surface Mount Bi-Color Chip LED Indicator



Technical Data Sheet

Features:

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Bi-color type.
- Color:Deep Red & Yellow Green.
- The product itself will remain within RoHS compliant Version.

Descriptions:

- The S155 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications, etc.

Applications:

- Backlighting in dashboard and switch.
- Telecommunication: Indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

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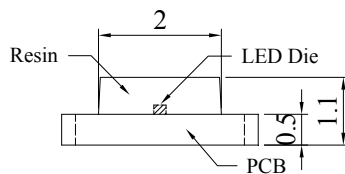
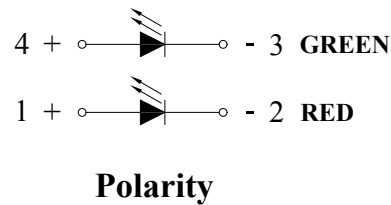
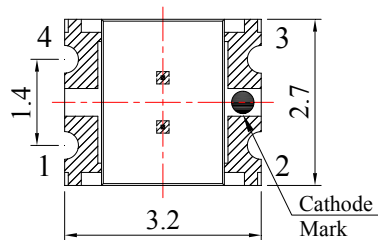
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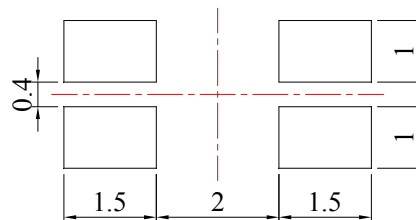
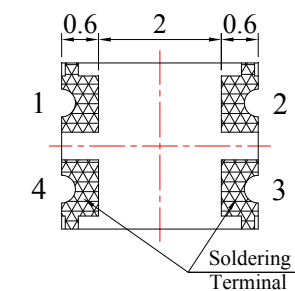
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Part No.	Emitting Color	Lens Color
S155SGC-2S-2A	S Deep Red	Water Clear
	G Yellow Green	

Package Dimension:



Recommended Soldering Pad Dimensions



Unit: mm
Tolerance: $\pm 0.10\text{mm}$

Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25\text{ mm}$ (.010") unless otherwise noted.

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Absolute Maximum Ratings at Ta=25°C

Parameters	Symbol	Emitting Color	Max.	Unit
Power Dissipation	PD	Deep Red	60	mW
		Yellow Green	60	
Peak Forward Current ^(a)	IFP	Deep Red	100	mA
		Yellow Green	100	
Continuous Forward Current ^(b)	IF	Deep Red	25	mA
		Yellow Green	25	
Reverse Voltage	VR	5		V
Electrostatic Discharge (HBM)	ESD	Deep Red	2000	V
		Yellow Green	2000	V
Operating Temperature Range	Topr	-40°C to +80°C		
Storage Temperature Range	Tstg	-40°C to +85°C		
Soldering Temperature	Tsld	260°C for 5 Seconds		

Notes:

a. Derate linearly as shown in derating curve.

b. Duty Factor = 10%, Frequency = 1 kHz

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Electrical Optical Characteristics at Ta=25°C

Parameters	Symbol	Emitting Color	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity ^(a)	IV	Deep Red	10	20	---	mcd	IF=20mA
		Yellow Green	10	20	---		
Viewing Angle ^(b)	2θ1/2	Deep Red	---	120	---	Deg	IF=20mA
		Yellow Green	---	120	---		
Peak Emission Wavelength	λp	Deep Red	---	660	---	nm	IF=20mA
		Yellow Green	---	565	---		
Dominant Wavelength ^(c)	λd	Deep Red	---	640	---	nm	IF=20mA
		Yellow Green	---	570	---		
Spectral Line Half-Width	Δλ	Deep Red	---	20	---	nm	IF=20mA
		Yellow Green	---	20	---		
Forward Voltage	VF	Deep Red	1.60	2.00	2.40	V	IF=20mA
		Yellow Green	1.60	2.00	2.40		
Reverse Current	IR	Deep Red	---	---	10	μA	VR=5V
		Yellow Green	---	---	10		

Notes:

- Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
- 2θ1/2 is the o -axis angle where the luminous intensity is 1/2 the peak intensity
- The dominant wavelength (λd) is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

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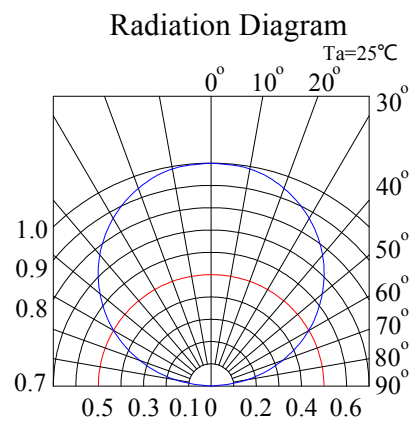
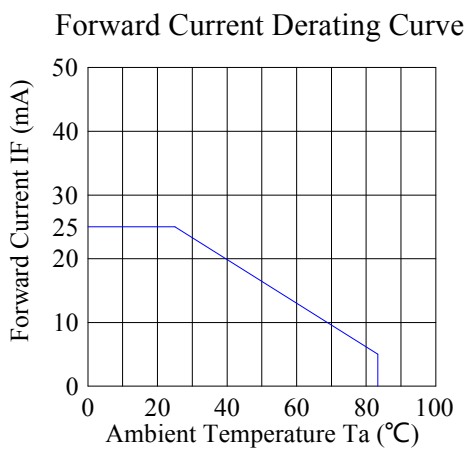
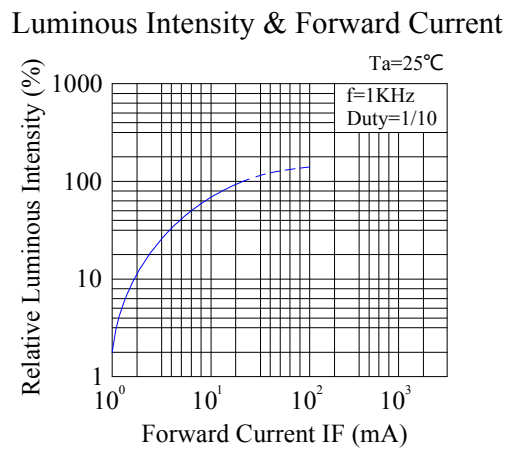
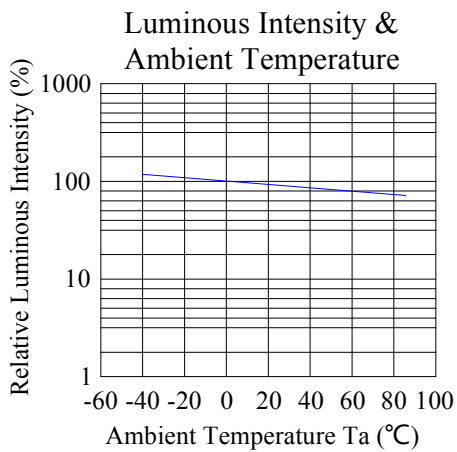
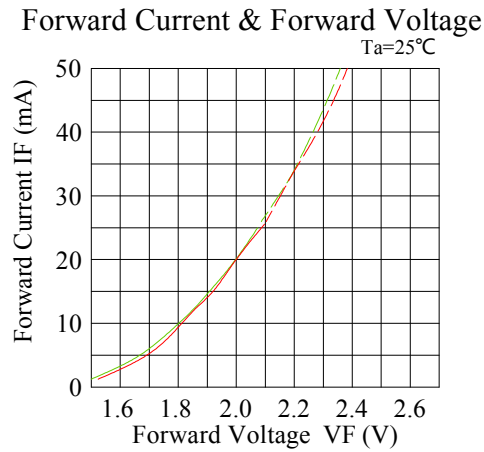
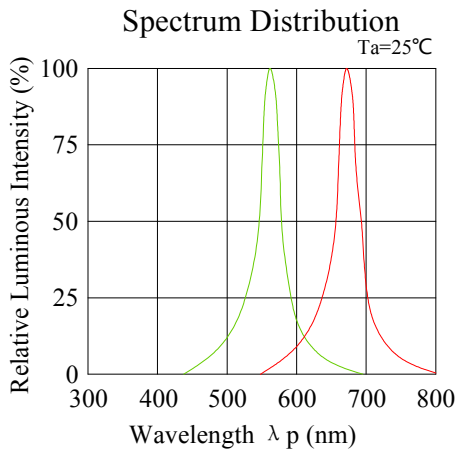
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Typical Electrical / Optical Characteristics Curves (25°C Ambient Temperature Unless Otherwise Noted)



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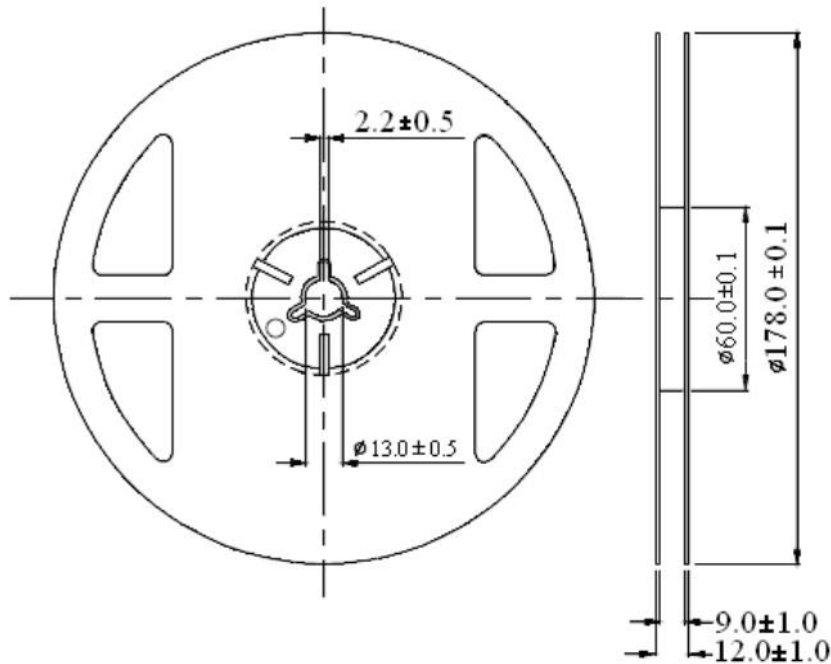
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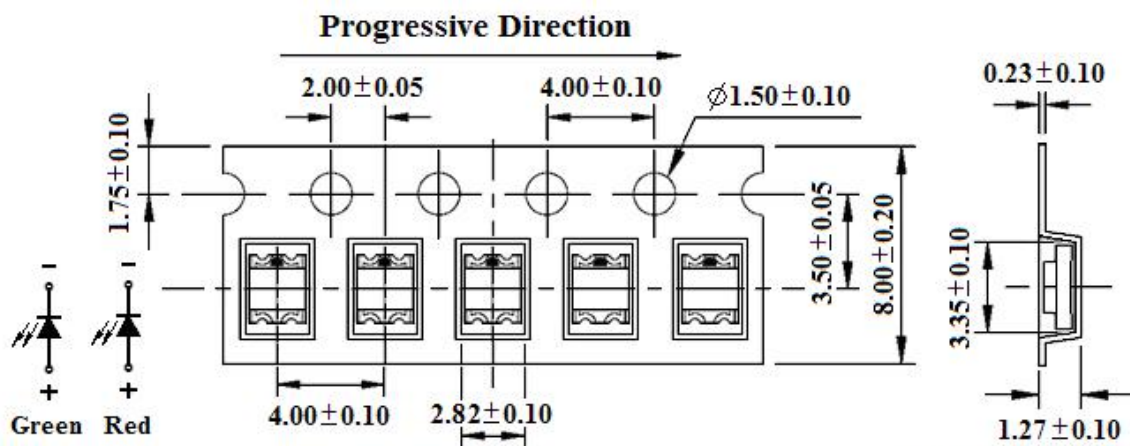
Reel Dimensions:



Unit: mm
Tolerance: ± 0.25mm

Carrier Tape Dimensions:

Loaded quantity 3000 pcs per reel.



Unit: mm
Tolerance: ± 0.10mm

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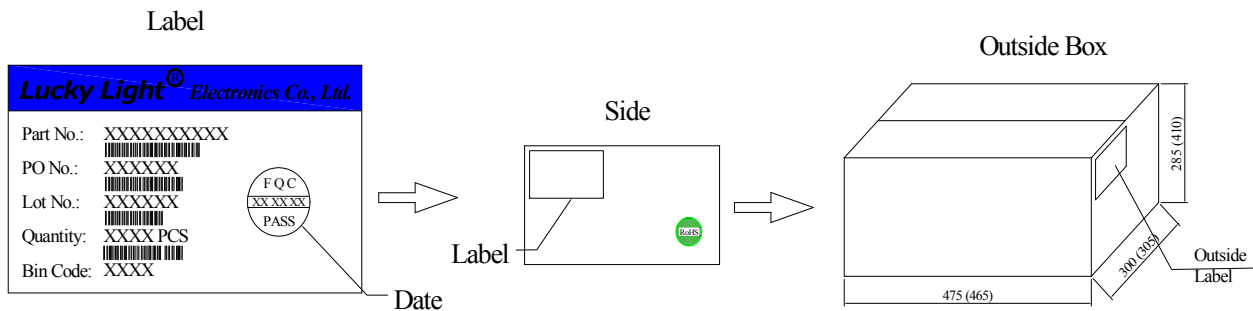
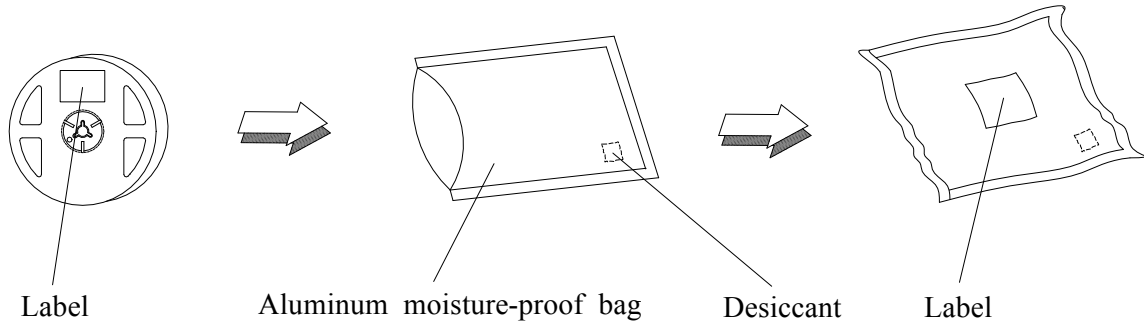
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Packing & Label Specifications:

Moisture Resistant Packaging:



Spec No.: S155

Issue No.: G-Rev-4

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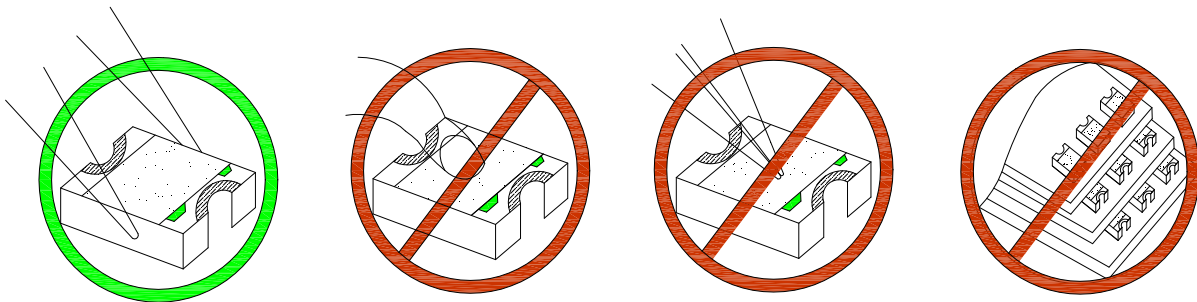
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CAUTIONS

1. Handling Precautions:

- 1.1. Handle the component along the side surfaces by using forceps or appropriate tools.
- 1.2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.
- 1.3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

2. Storage

- 2.1. Do not open moisture proof bag before the products are ready to use.
- 2.2. Before opening the package, the LEDs should be kept at 30°C or less and 60%RH or less.
- 2.3. The LEDs should be used within a year.
- 2.4. After opening the package, the LEDs should be kept at 30°C or less and 60%RH or less.
- 2.5. The LEDs should be used within 168 hours after opening the package.
- 2.6. If the moisture adsorbent material has fabled away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 65±5°C for 24 hours.

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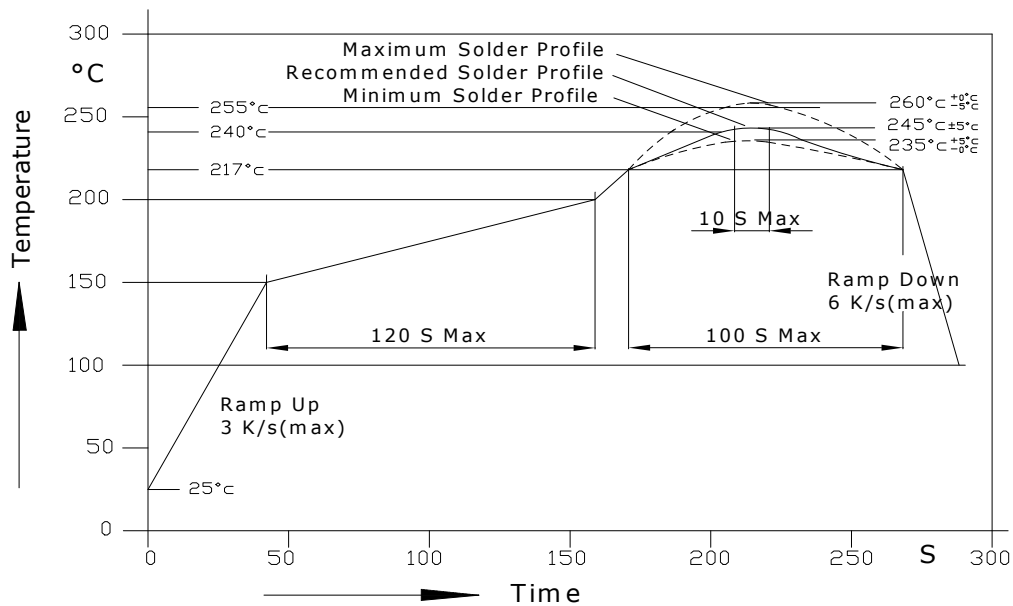
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3. Soldering Condition

3.1. Pb-free solder temperature profile



3.2. Reflow soldering should not be done more than two times.

3.3. When soldering, do not put stress on the LEDs during heating.

3.4. After soldering, do not warp the circuit board.

3.5. Recommended soldering conditions:

Reflow soldering		Soldering iron	
Pre-heat	150~200°C	Temperature	300°C Max.
Pre-heat time	120 sec. Max.	Soldering time	3 sec. Max.
Peak temperature	260°C Max.		(one time only)
Soldering time	10 sec. Max.(Max. two times)		

3.6. Because different board designs use different number and types of devices, solder pastes, reflow ovens, and circuit boards, no single temperature profile works for all possible combinations.

However, you can successfully mount your packages to the PCB by following the proper guidelines and PCB-specific characterization.

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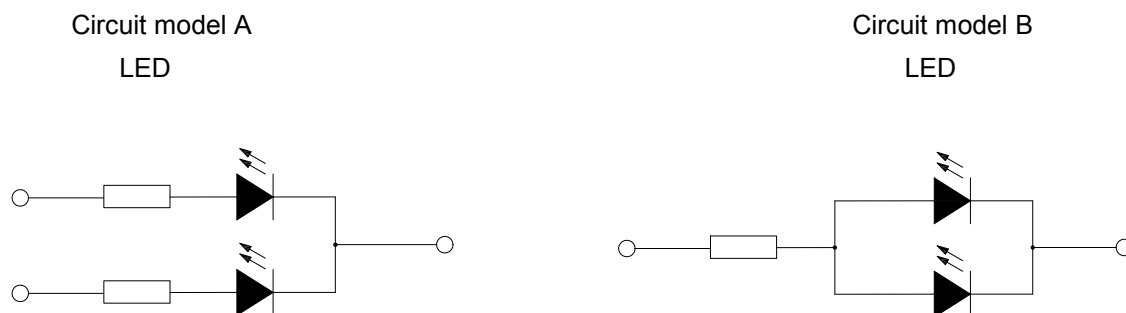
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4. Drive Method

4.1. An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.



a. Recommended circuit.

b. The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

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